



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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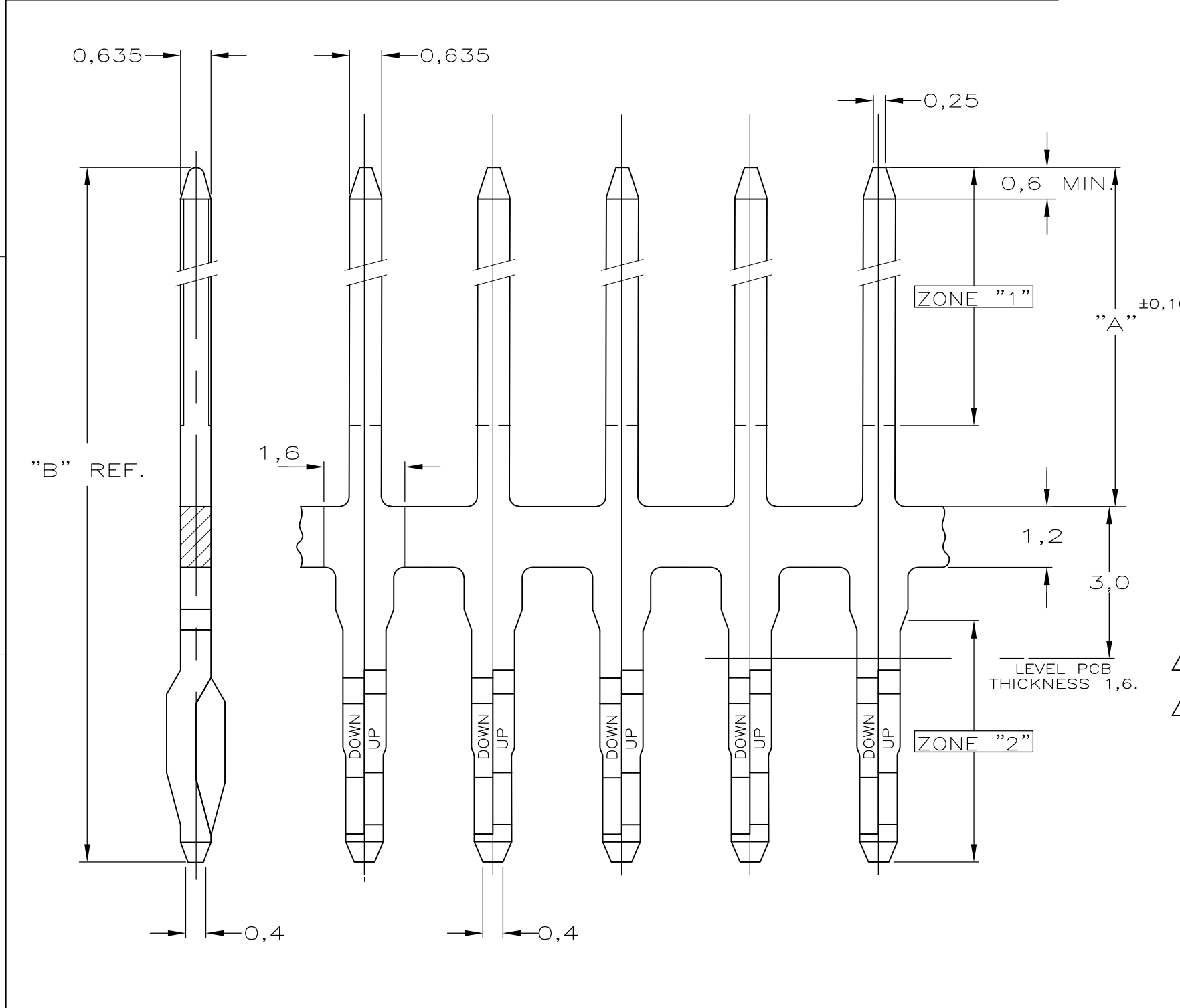
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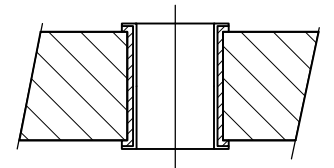
LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
-	-		R2	REFERENCE TO Sn/Pb PLATING CORRECTED TO Sn	27JUN2012	MHM	RP



NOTES:

- ① ZONE "1" DIMENSION = 5,0 MIN. EXCEPT FOR 1-215345-1 PLATING ZONE = 4,1 MIN.
- ② BRIGHT TIN PLATING ALL OVER.
- ③ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI

DIM: "B"	DIM: "A"	ZONE 2	LAYER I	LAYER II	ENTIRE UNDERCOATING	PART NUMBER STRIP
20,8	13,9	②	2,5µm Sn		1,3-2,5 Ni	1-215345-8
20,8	13,9		UNPLATED		1,3-2,5 Ni	1-215345-7
15,7	8,8	1,3 Sn	Au FLASH	0,8Au	1,3-2,5 Ni	1-215345-6
15,7	8,8	UNPLATED	UNPLATED	UNPLATED	1,3-2,5 Ni	1-215345-5
③ 13,6	6,7	②	1,27µm Sn		1,3-2,5 Ni	1-215345-4
17,0	10,1	②	2,5µm Sn		1,3-2,5 Ni	1-215345-3
③ 13,6	6,7	1,3 Sn	Au FLASH	0,8Au	1,3-2,5 Ni	1-215345-2
12,7	5,8	1,3 Sn	Au FLASH	1,3 Au	1,3-2,5 Ni	1-215345-1
12,7	5,8	UNPLATED	UNPLATED	UNPLATED	UNPLATED	1-215345-0
17,0	10,1	1,3 Sn	Au FLASH	0,8 Au	1,3-2,5 Ni	215345-9
13,6	6,7	1,3 Sn	0,8 Au	0,8 Au	1,3-2,5 Ni	215345-8
17,0	10,1	1,3 Sn	Au FLASH	1,3 Au	min.2,0 Ni	215345-7
13,6	6,7	1,3 Sn	Au FLASH	1,3 Au	min.2,0 Ni	215345-6
17,0	10,1	1,3 Sn	Au FLASH	1,3 Au	1,3-2,5 Ni	215345-5
17,0	10,1	UNPLATED	UNPLATED	UNPLATED	UNPLATED	215345-4
13,6	6,7	1,3 Sn	Au FLASH	1,3 Au	1,3-2,5 Ni	215345-3
13,6	6,7	1,3 Sn	Au FLASH	0,8 Au	1,3-2,5 Ni	215345-2
13,6	6,7	UNPLATED	UNPLATED	UNPLATED	UNPLATED	215345-1
MIN. PLATING-THICKNESS IN µm						



P.C.B. HOLE DIM. ACTION PIN	
DRILLED HOLE	:1,15 ±0,025 mm
FIN. HOLE	:0,94 to 1,09 mm
AFTER REFLOW	:0,91 to 1,09 mm
Cu-thickness	: 0,025 to 0,075 mm
Sn-thickness	: 0,004 to 0,010 mm

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN R.d.B. 20 NOV 95	TE Connectivity	
		CHK J.v.LIEMPT 20 NOV 95		
DIMENSIONS: mm		APVD J.v.LIEMPT -	NAME	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		PRODUCT SPEC	MODU MOD II POST WITH ACTION-PIN POST	
0 PLC ± -		APPLICATION SPEC	SIZE CAGE CODE DRAWING NO RESTRICTED TO	
1 PLC ± -		WEIGHT -	A3 00779 C-215345	
2 PLC ± -		CUSTOMER DRAWING		
3 PLC ± -		SCALE 10:1 SHEET 1 OF 1 REV R2		
4 PLC ± -				
ANGLES ± -				
MATERIAL PHOSPHOR BRONZE	FINISH SEE TABLE			